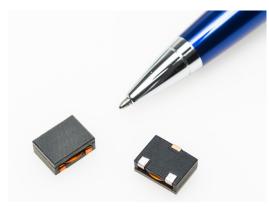
Effective April 2015 Supersedes December 2014

# Coiltronics HCV1206 Family High current power inductors



### Description

- Flat-wire construction
- Low DCR, high efficiency
- Secure 3 terminal mounting
- 12.7 x 10.15mm footprint surface mount package in a 5.1mm height
- Ferrite core material
- Halogen free, lead free, RoHS compliant

### Applications

 Compatible with Picor<sup>®</sup> Cool-Power<sup>®</sup>
ZVS Buckand Buck-Boost Regulator Families (Picor part number series PI37xx and PI35xx)

#### **Environmental Data**

- Storage temperature range (component): -55°C to +125°C
- Operating temperature range: -55°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant



Picor® and Cool-Power® are trademarks of Vicor Corporation.



Coiltronics is now part of Eaton Same great products plus even more.



The Coiltronics brand of magnetics (formerly of the Bussmann Division of Cooper Industries) is now part of Eaton's Electrical Group, Electronics Division.

### HCV1206 Family High current power inductors

### **Product Specifications**

Part Number⁴	OCL <sup>1</sup> (μΗ) ±10%	l <sub>rms²</sub> (amps)	l <sub>sat</sub> ³ (amps)	DCR (mΩ) @ 20°C ±10%
HCV1206-R42-R	0.42	16	42	3.15
HCV1206-R48-R	0.48	16	37	3.15
HCV1206-R90-R	0.90	14	28	4.6
HCV1206-1R0-R	1.0	14	24.5	4.6
HCV1206-1R5-R	1.5	12	21	6.0
HCV1206-2R0-R	2.0	12	16	6.0
HCV1206-3R0-R	3.0	11	13	7.4

1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc, 25°C

2. I<sub>mm</sub>: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

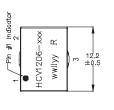
3.  $I_{sat}$  : Peak current for approximately 5% rolloff @ +25°C

4. Part Number Definition: HCV1206-xxx-R

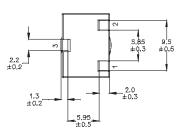
HCV1206 = Product code and size xxx=Inductance value in uH.

-R suffix = RoHS compliant

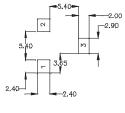
### Dimensions (mm)







### Recommended Pad Layout



Schematic



## 9,8 ±0.35

Part marking: HCV1206-xxx, xxx=inductance value in µH, R=decimal point,

wwllyy= date code, R=revision level

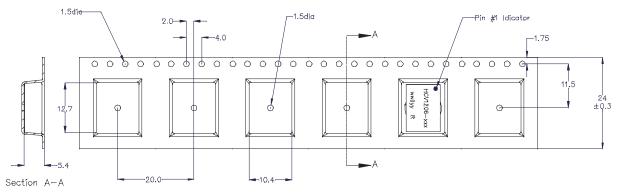
Soldering surfaces to be coplanar within 0.1 millimeters

Pin 3 is for mounting stability. No connection.

Do no route traces or vias underneath the inductor.

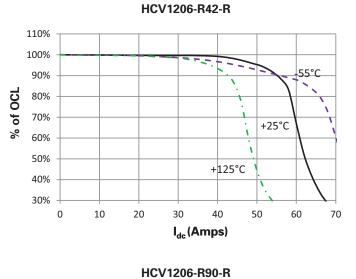
### Packaging information (mm)

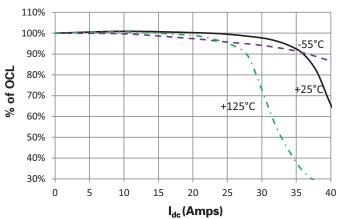
Supplied in tape and reel packaging, 550 parts per 13" diameter reel

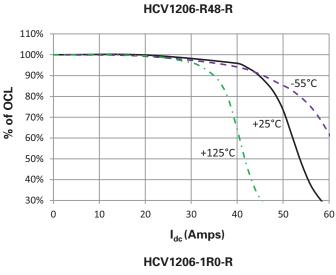


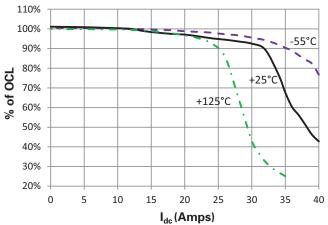
Direction of feed

### Inductance characteristics









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### Inductance characteristics

110% 100%

90%

80%

70%

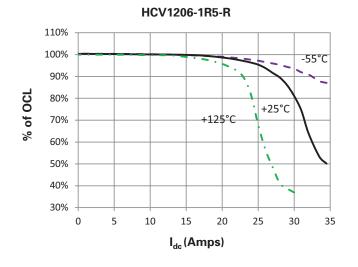
60%

50%

40% 30%

0 2 4 6 8

% of OCL



HCV1206-3R0-R

I<sub>dc</sub> (Amps)

-55<sup>°</sup>C

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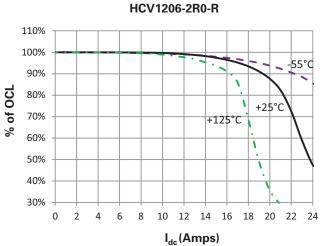
10 12 14 16 18 20 22 24

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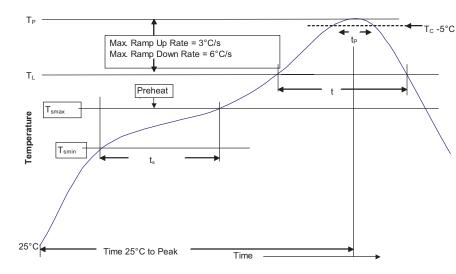
-125°C 🔪

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### Solder reflow profile



### $-_{T_c - 5^{\circ}C}$ Table 1 - Standard SnPb Solder (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm³ ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

### Table 2 - Lead (Pb) Free Solder (T<sub>c</sub>)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

### **Reference JDEC J-STD-020D**

Powering Business Worldwide

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T <sub>smin</sub> )	100°C	150°C	
• Temperature max. (T <sub>smax</sub> )	150°C	200°C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds	
Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature $(T_c)$	20 Seconds**	30 Seconds**	
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

\* Tolerance for peak profile temperature  $(T_n)$  is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

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